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CONTENTS

MICRO- AND NANO-SYSTEMS ENGINEERING AND PACKAGING

APPLICATIONS OF MICRO AND NANO SYSTEMS IN MEDICINE AND BIOLOGY

IMECE2019-11470..... **V010T12A001**

Microfluidic Temperature Behavior in a Multi-Material 3D Printed Chip

Derek Sanchez, Greg Nordin, Troy Munro

IMECE2019-11534..... **V010T12A002**

Fabrication, Modeling, and Testing of a Miniaturized Fast Neutron Detector

Samuel W. Oxandale, Luke A. Stegeman, Tyler J. Hieber, Dipta Sarkar, Steven L. Bellinger, Amir A. Bahadori, Zayd C. Leseman

IMECE2019-11618..... **V010T12A003**

Study of Low-Frequency Narrow Bandwidth Surface Acoustic Wave Sensor for Liquid Applications

Kun-Lin Lee, Ioana Voiculescu

APPLIED MECHANICS AND MATERIALS IN MICRO- AND NANO-SYSTEMS

IMECE2019-10450..... **V010T12A004**

Performance Variation of Nano-Scaled Devices in 3D-IC Packaging Architecture Induced by TSV Residual Stress

Chang-Chun Lee, Pei-Chen Huang, Chi-Wei Wang

IMECE2019-10558..... **V010T12A005**

Electromigration Analysis of Power Modules by Electrical-Thermal-Mechanical Coupled Model

Mitsuaki Kato, Takahiro Omori, Akihiro Goryu, Tomoya Fumikura, Kenji Hirohata

IMECE2019-11349..... **V010T12A006**

Validation of an Atomistic Field Theory for Contact Electrification Using a MEMS Load Cell

Tyler J. Hieber, Mohamad Ibrahim Cheikh, James M. Chen, Zayd C. Leseman

IMECE2019-11466..... **V010T12A007**

Opportunities for Radiation Pressure in Characterization of Micro- / Nano-Materials

Zayd C. Leseman

IMECE2019-11690..... **V010T12A008**

Thermal Property Measurements of Si [micro]-Cantilever Beams Using the Suspended Thermoreflectance Technique

Dipta Sarkar, Samuel W. Oxandale, Tyler J. Hieber, M. G. Baboly, Zayd C. Leseman

COMPUTATIONAL STUDIES ON MEMS AND NANOSTRUCTURES

IMECE2019-10059..... **V010T12A009**

First-Principle Calculations of the Binding Energy of the Coating Components of New Generation Dental Implants

Alla V. Balueva, Iliia N. Dashevskiy, Patricia Todebush, Chasen Campbell, Eduardo Valdez

IMECE2019-11107..... **V010T12A010**

First Principle Analysis of the Effect of Strain on Electronic Transport Properties of Dumbbell-Shape Graphene Nanoribbons

Takuya Kudo, Qinqiang Zhang, Ken Suzuki, Hideo Miura

IMECE2019-11496..... **V010T12A011**

Optimization of a Manifold Microchannel Heat Sink Using an Improved Version of the Augmented Epsilon Constraint Method

L. K. Tartibu, M. O. Okwu

DESIGN AND FABRICATION, ANALYSIS, PROCESSES, AND TECHNOLOGY FOR MICRO AND NANO DEVICES AND SYSTEMS

IMECE2019-10629..... **V010T12A012**

Non-Invasive Tracking of Micro-Scale Microrobot Using Photoacoustic Imaging

Yan Yan, Zachary Carey, Mohammad Mehrmohammadi, Wuming Jing

IMECE2019-11106..... **V010T12A013**

Measurement of the Residual Stress Distribution in the 3D-Stacked Electronic Modules by Embedded Strain Sensors

Ryota Mizuno, Genta Nakauchi, Ken Suzuki, Hideo Miura

IMECE2019-11181..... **V010T12A014**

Packaging Challenges of Thin High Bandwidth POP

Fletcher (Cheng-Piao) Tung, Jensen (Ying-Chou) Tsai, Yu-Po Wang, Joe (Chih-Nan) Lin, Gary (Yue-Long) Fan

IMECE2019-11921..... **V010T12A015**

Design and Fabrication of a Multi-Scale Fluidic Motherboard for a Universal Molecular Processing System (uMPS)

D. S. Park, M. Witek, X. Zhao, Y. Kang, K. Dathathreya, B. H. You, S. A. Soper, M. C. Murphy

GENERAL TOPICS OF MEMS/NEMS

IMECE2019-11076..... **V010T12A016**

Strain and Photovoltaic Sensitivities of Dumbbell-Shape GNR-Base Sensors

Jowesh Avisheik Goundar, Takuya Kudo, Qinqiang Zhang, Ken Suzuki, Hideo Miura

IMECE2019-12270..... **V010T12A017**

Flexible Valveless Pump for Bio Applications

Masoud Naghdi, Farhad Farzbod, Paul M. Goggans

MICROFLUIDICS 2019: MICROFLUIDICS IN MICRO- AND NANOSYSTEMS

IMECE2019-10426..... **V010T12A018**

Scaling Behavior in Electrohydrodynamic Jetting of Polymeric Solutions

Abhishek K. Singh, Kaushlendra Dubey, Rajiv K. Srivastava, Supreet Singh Bahga

IMECE2019-10466..... **V010T12A019**

Analysis of Combined Electroosmotic and Pressure Driven Flow of Multilayer

Immiscible Fluids in a Narrow Capillary

Juan P. Escandon, David A. Torres

IMECE2019-11708..... **V010T12A020**

Study of Angle-of-Attack (AoA) for Airfoil in Deterministic Lateral Displacement (DLD)

Kawkab Ahasan, Jong-Hoon Kim

IMECE2019-11734..... **V010T12A021**

DC-Biased AC Electrokinetics Effect on V-Shaped Electrode Patterns for Microfluidics Applications

Mohammad Salman Parvez, Mohammad Fazlay Rubby, Samir Iqbal, Nazmul Islam

IMECE2019-11903..... **V010T12A022**

Microfluidic-Based Fabrication and Dielectrophoretic Manipulation of Microcapsules

Sepehr Maktabi, Jeffrey W. Schertzer, Paul R. Chiarot

ADDENDUM

IMECE2019-12129..... **V010T12A023**

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